



Product Change Notification - JAON-06DMAC213

Date:

20 Aug 2019

Product Category:

Others; Ethernet Switches

Affected CPNs:**Notification subject:**

CCB 3599 and 3599.001 Final Notice: Qualification of ASE as a new assembly site for selected Micrel products available in 128L PQFP (14x20x2.72mm) package.

Notification text:**PCN Status:**

Final notification

PCN Type:

Manufacturing Change

Microchip Parts Affected:

Please open one of the icons found in the Affected CPNs section above.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

Description of Change:

Qualification of ASE as a new assembly site for selected Micrel products available in 128L PQFP (14x20x2.72mm) package.

Pre Change:

Assembled at TICIP using EN4900 die attach and CEL-9200 mold compound

Post Change:

Assembled at ASE using CRM-1076WA die attach and EME-G631H mold compound

Pre and Post Change Summary:

	Pre Change	Post Change
Assembly Site	Taiwan IC Packing Corp. (TICIP)	ASE Inc. (ASE)
Wire material	Au	Au
Die attach material	EN4900	CRM-1076WA
Molding compound material	CEL-9200	EME-G631H
Lead frame material	C7025	C7025

Impacts to Data Sheet:

None

Change Impact:

None

Reason for Change:

To improve productivity and on-time delivery performance by qualifying ASE as a new additional assembly site.

Change Implementation Status:

In Progress

Estimated First Ship Date:

September 20, 2019 (date code: 1938)



NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts

Time Table Summary:

	December 2018					->	August 2019					September 2019			
Workweek	48	49	50	51	52		31	32	33	34	35	36	37	38	39
Initial PCN Issue Date				X											
Qual Report Availability										X					
Final PCN Issue Date										X					
Estimated Implementation Date														X	

Method to Identify Change:

Traceability code

Qualification Report:

Please open the attachments included with this PCN labeled as PCN_#_Qual Report.

Revision History:

December 19, 2018: Issued initial notification.

August 20, 2019: Issued final notification. Attached the qualification report. Provided the estimated first ship date to be on September 20, 2019.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s):

[PCN_JAON-06DMAC213_Qual_Report.pdf](#)

Please contact your local [Microchip sales office](#) with questions or concerns regarding this notification.

Terms and Conditions:

If you wish to receive Microchip PCNs via email please register for our PCN email service at our [PCN home page](#) select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the [PCN FAQ](#) section.

If you wish to change your PCN profile, including opt out, please go to the [PCN home page](#) select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

Affected Catalog Part Numbers (CPN)

KSZ8342Q
KSZ8382Q
SPNY801158
SPNY801158-TR
SPNY801159
SPNY801159-TR
SPNY801160
SPNY801160-TR
SPNY801170
SPNY801171
SPNY801172
SPNY801172-TR
SPNZ801158
SPNZ801158-TR
SPNZ801159
SPNZ801159-TR
SPNZ801160
SPNZ801160-TR
SPNZ801170
SPNZ801171
SPNZ801172